

STN1NK60ZL

N-channel 600 V, 10.4 Ω typ., 0.44 A SuperMESH™ Power MOSFET in a SOT-223 package

Datasheet - production data

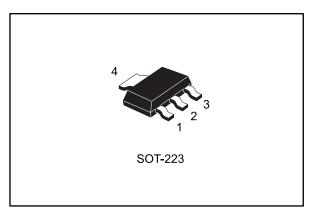
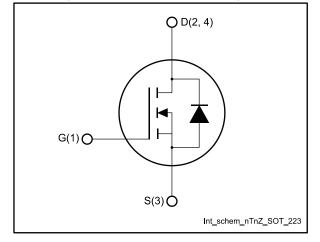


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D	Ртот
STN1NK60ZL	600 V	15 Ω	0.44 A	3.3 W

- 100% avalanche tested
- Extremely high dv/dt capability
- · Gate charge minimized
- ESD improved capability

Applications

Switching applications

Description

This high voltage device is an N-channel Power MOSFET developed using the SuperMESH™ technology by STMicroelectronics, an optimization of the well-established PowerMESH™. In addition to a significant reduction in on-resistance, this device is designed to ensure a high level of dv/dt capability for the most demanding applications.

Table 1: Device summary

Order code	Marking	Package	Packing
STN1NK60ZL	1NK60ZL	SOT-223	Tube

Contents STN1NK60ZL

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STN1NK60ZL Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	600	V	
V_{GS}	Gate-source voltage	±20	V	
ΙD	Drain current (continuous) at T _{amb} = 25 °C	0.44	Α	
ΙD	Drain current (continuous) at T _{amb} = 100 °C	0.3	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	1.8	Α	
Ртот	Total dissipation at T _{amb} = 25 °C	3.3	W	
dv/dt (2)	Peak diode recovery voltage slope	3	V/ns	
Tj	Operating junction temperature range	55 to 150	°C	
T _{stg}	Storage temperature range			

Notes:

Table 3: Thermal data

Sy	/mbol	Parameter	Value	Unit
Rth	nj-amb ⁽¹⁾	Thermal resistance junction- ambient max	38	°C/W

Notes:

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
Iar	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	0.3	А
Eas	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}, V_{DD} = 50 \text{ V}$)	150	mJ

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \le 0.3$ A, di/dt ≤ 200 A/ μ s, $V_{DD} = 80\%V_{(BR)DSS}$

 $^{^{(1)}}$ When mounted on 1 inch² FR-4 board, 2 Oz Cu, t < 3 s $\,$

Electrical characteristics STN1NK60ZL

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	600			V
I _{DSS} Zero gate voltage drain current		$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 50 \mu A$	0.9	1.7	2	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 0.25 A		10.4	15	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	125	1	pF
Coss	Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V},$ f = 1 MHz		-	13	ı	pF
Crss	Reverse transfer capacitance		-	2	ı	pF
Qg	Total gate charge $V_{DD} = 480 \text{ V}, I_D = 0.8 \text{ A}$		-	9.4	-	nC
Qgs	Gate-source charge V _{GS} = 10 V		-	0.8	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	4.5	1	nC

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD}=300 \text{ V}, I_{D}=0.4 \text{ A},$	ı	4.4	-	ns
tr	Rise time	$R_G = 4.7 \Omega$	-	4	-	ns
t _{d(off)}	Turn-off delay time	V _{GS} = 10 V (see Figure 14: "Test circuit - for resistive load switching times" and Figure 19: "Switching time waveform")	-	18.4	-	ns
t _f	Fall time		ı	41	-	ns

⁽¹⁾Defined by design, not subject to production test.

Table 8: Source-drain diode

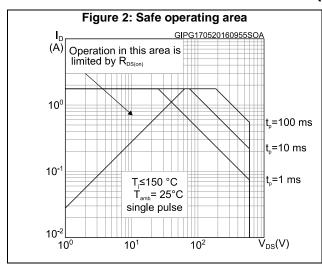
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		0.44	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		1.8	Α
V _{SD} ⁽²⁾	Forward on voltage	V _G S = 0 V, I _{SD} = 0.44 A	1		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 0.8 A,	-	155		ns
Qrr	Reverse recovery charge	di/dt = 100 A/µs,V _{DD} = 60 V (see <i>Figure 16: "Test circuit</i>	1	232		nC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	ı	3		Α
t _{rr}	Reverse recovery time	$I_{SD} = 0.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	186		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 16: "Test circuit	-	297		nC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	-	3.2		Α

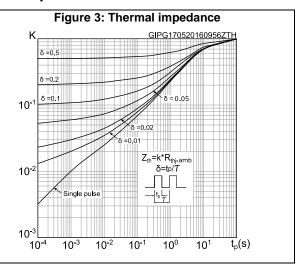
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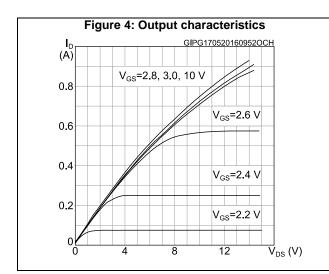
⁽¹⁾Pulse width limited by safe operating area

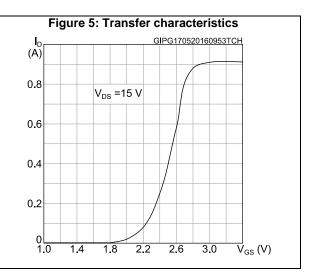
 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%

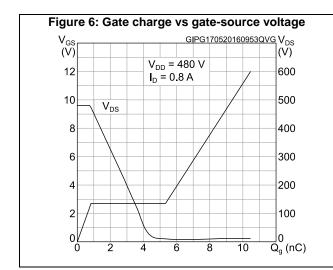
2.2 Electrical characteristics (curves)

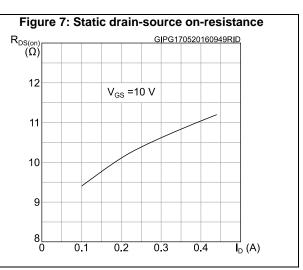








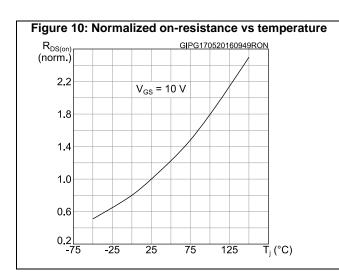


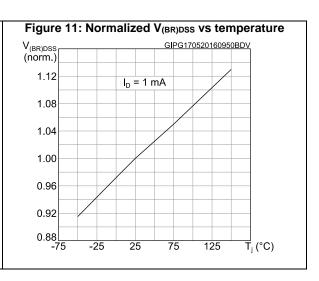


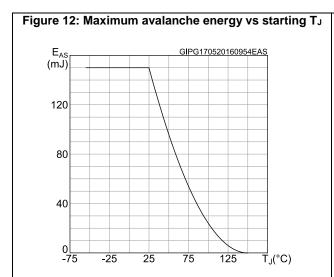
STN1NK60ZL Electrical characteristics

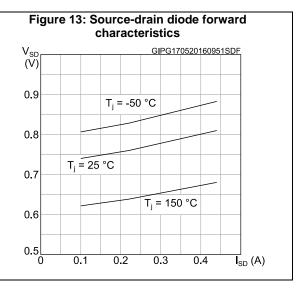
Figure 8: Capacitance variations C (pF) GIPG170520160951CVR $\mathsf{C}_{\mathsf{ISS}}$ 10^{2} 10 C_{oss} $\mathsf{C}_{\mathsf{RSS}}$ f = 1 MHz 10⁰ 10⁻¹ $\bar{V}_{DS}\left(V\right)$ 10⁰ 10⁻¹ 10¹ 10^{2}

Figure 9: Normalized gate threshold voltage vs temperature V_{GS(th)} (norm.) GIPG170520160948VTH 1.1 $I_{D} = 50 \, \mu A$ 1.0 0.9 8.0 0.7 0.6L -75 -25 25 75 125 T_i (°C)









Test circuits STN1NK60ZL

3 Test circuits

Figure 14: Test circuit for resistive load switching times

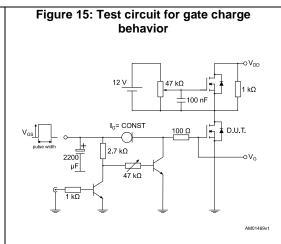
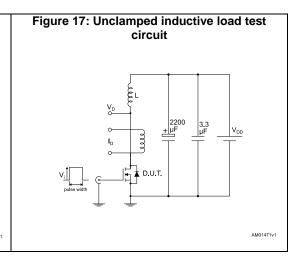
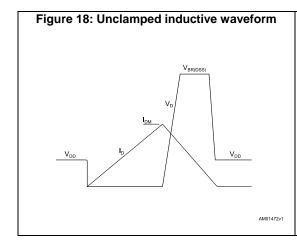
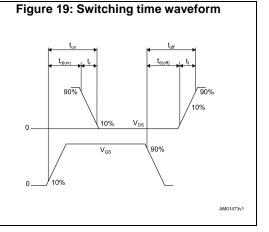


Figure 16: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 SOT-223 package information

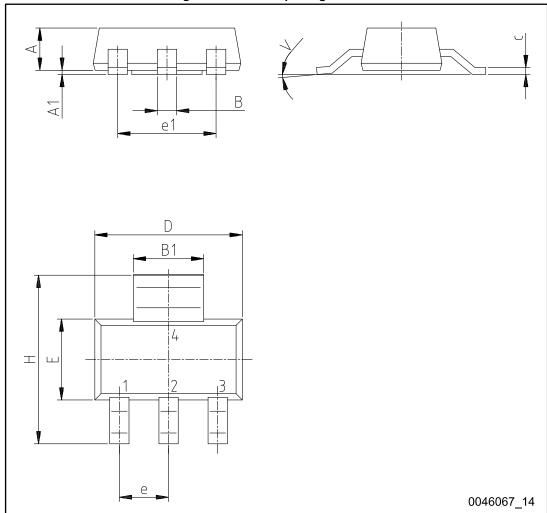
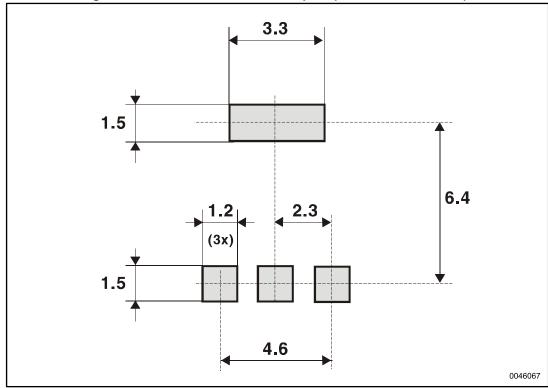


Figure 20: SOT-223 package outline

Table 9: SOT-223 package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А			1.8
A1	0.02		0.1
В	0.6	0.7	0.85
B1	2.9	3	3.15
С	0.24	0.26	0.35
D	6.3	6.5	6.7
е		2.3	
e1		4.6	
Е	3.3	3.5	3.7
Н	6.7	7.0	7.3
V			10°

Figure 21: SOT-223 recommended footprint (dimensions are in mm)



STN1NK60ZL Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
12-Nov-2015	1	First release.
05-Dec-2016	2	Modified: features in cover page Modified Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Avalanche characteristics", Table 5: "On/off-state", Table 6: "Dynamic", Table 7: "Switching times" and Table 8: "Source-drain diode" Datasheet promoted from preliminary data to production data Modified Section 3.1: "Electrical characteristics (curves)" Minor text changes

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